

## Silicon Bipolar MMIC Cascadable Amplifier

### MAAM41034

#### Features

- Cascadable 50Ω Gain Block
- 15 dB Power Gain at 0.5 GHz
- Medium Power: +13 dBm at 1 GHz
- Single Positive Supply: +3.3 to +12V
- Temperature Range: -55 to +95°C
- Low Cost, Low Inductance Plastic Surface Mount Package

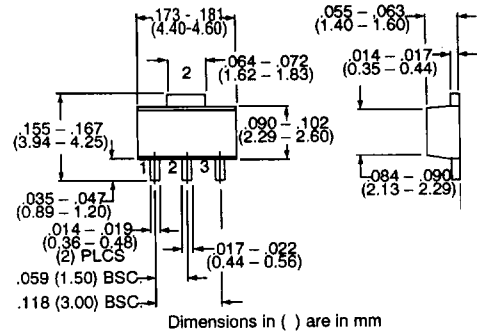
#### Description

M/A-COM's MAAM41034 is a high performance medium power cascadable gain block amplifier in a low inductance plastic surface mount package. The MAAM41034 is ideally suited for use where a general purpose amplifier with moderate power consumption from a low voltage supply is required. Typical applications include narrow and wide band RF and IF amplifiers in systems such as GPS receivers, fiber optic modules, cordless phones and battery powered radio receivers.

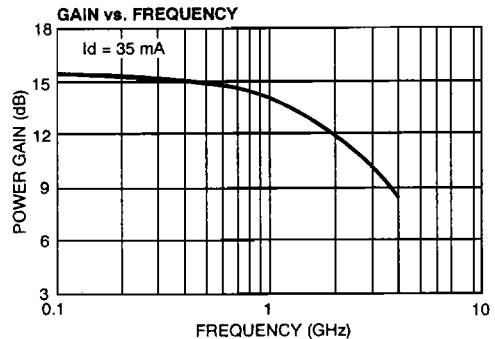
The MAAM41034 is based on the Darlington pair with internal feedback configuration. It can operate over a narrow or wide frequency range with useful power gain up to 2 GHz over the full military temperature range.

The MAAM41034 is fabricated with a monolithic chip using a mature, 12 GHz  $f_t$  silicon bipolar technology. The process features full IC passivation for increased performance and reliability.

#### SOT-89



Pin Description	
1	RF Input
2	AC/DC Ground
3	RF Output/Bias



#### Electrical Specifications, $T_A = 25^\circ\text{C}$

Symbol	Parameters, Test Conditions: $I_d = 35 \text{ mA}$ $Z_o = 50\Omega$	Units	Min.	Typ.	Max.
$G_p$	Power Gain $f = 0.1 \text{ GHz}$	dB	15	15.5	16.5
$\Delta G_p$	Gain Flatness $f = 0.1 \text{ GHz to } 1 \text{ GHz}$	dB		$\pm 0.6$	
$F_{1dB}$	1 dB Bandwidth	MHz		800	
$F_{3dB}$	3 dB Bandwidth	MHz		1600	
$S_{12}$	Reverse Isolation $f = 0.1 \text{ GHz to } 1.5 \text{ GHz}$	dB		-18	
$IP_3$	Third Order Intercept Point $f = 1 \text{ GHz}$	dBm		+24	
$P_{1dB}$	Output Power @ 1 dB Gain Compression $f = 1 \text{ GHz}$	dBm		13	
$NF_{50\Omega}$	Noise Figure measured with a 50Ω source $f = 1 \text{ GHz}$	dB		5.5	
VSWR	RF Input $f = 0.05 \text{ to } 1.5 \text{ GHz}$			1.5:1	
VSWR	RF Output $f = 0.05 \text{ to } 1.5 \text{ GHz}$			1.5:1	
$t_d$	Group Delay $f = 1 \text{ GHz}$	psec		350	
$V_d$	Device Voltage	Volt	2.8	3.3	3.75
$dV/dT$	Device Voltage to Temperature Coefficient ( $I_d=35 \text{ mA}$ )	mV/°C		-5	

Specifications Subject to Change Without Notice

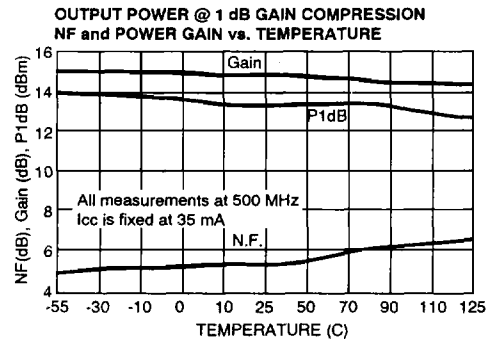
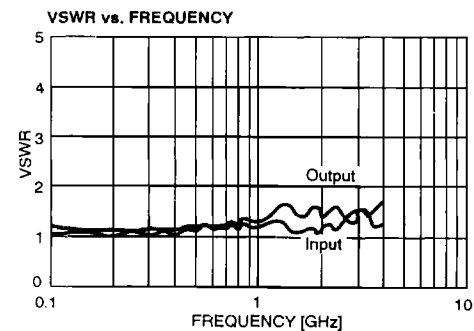
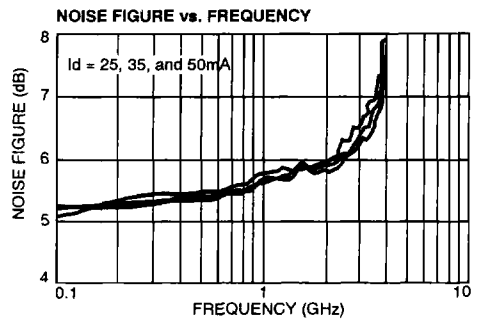
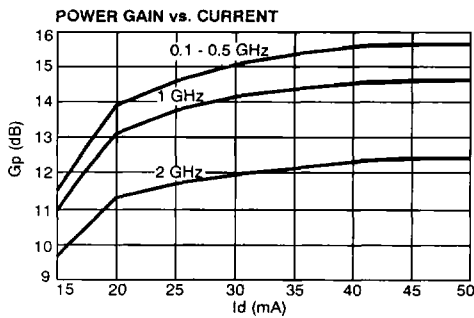
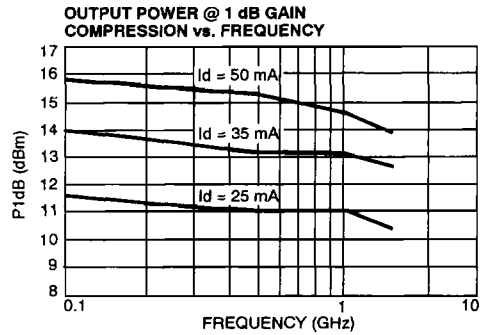
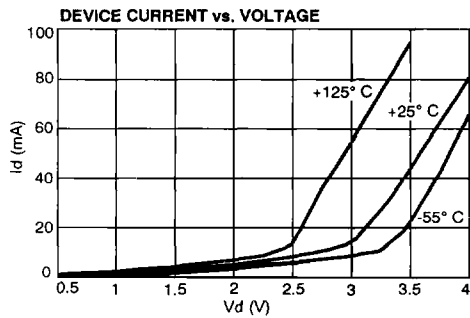
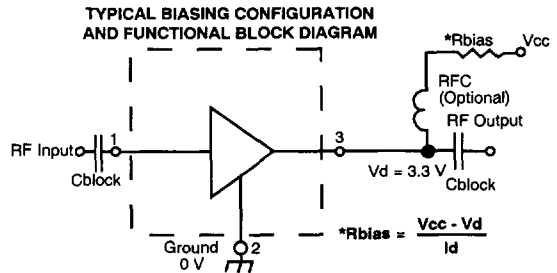
**Absolute Maximum Ratings**

Parameter	Absolute Maximum
Device Current	75 mA
Power Dissipation <sup>2,3</sup>	200 mW
RF Input Power	+13 dBm
Junction Temperature	150°C
Storage Temperature	-65°C to 150°C
Thermal Resistance: $\theta_j = 55^\circ\text{C/W}$	

Notes:

1. Operation outside these limits may result in permanent damage.
2.  $T_{\text{case}}$  - Case temperature = 25°C (Bottom of the case)
3. Derate at 18.18 mW/°C for  $T_{\text{case}} > 139^\circ\text{C}$

**Typical Performance,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)**



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